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jc905 U.S. PTO

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Docket No. 17498

Express Mail No. EL046239260US

Date: October 3, 2000

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09/678519

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TRANSMITTAL OF PATENT APPLICATION FOR FILING

Dear Sir:

Transmitted herewith for filing is a patent application of:

Inventor(s): Randy Gray Simmons and Kevin John Peterson

For: PCMCIA Card

Enclosed are papers, identified as follows:

- ☒ Specification and Claims
- ☒ Declaration or Oath and Petition, Power of Attorney  
\_\_\_\_\_ To follow if this line is checked
- ☒ Sheets of Drawings
- ☒ Informal if this line is checked
- \_\_\_\_\_ Certified Copy of Priority Document

— This application claims the benefit under 35 USC §119(e) of a prior U.S. Provisional Application. Please amend the Specification by inserting, before the first line, the following sentence:  
 "This application claims the benefit of U.S. Provisional Application(s) No(s). \_\_\_\_\_, filed \_\_\_\_\_."

An Assignment is:

- ☒ enclosed, signed by the inventor and the requisite cover sheet therefor; or
- \_\_\_\_\_ to follow if this line is checked.

A filing fee is calculated as follows:

Basic Fee .....	=	\$ 690
Total Claims <u>14</u> minus 20 = * <u>0</u>	X \$ 18 =	\$ 0
Independent <u>2</u> minus 3 = * <u>0</u>	X \$ 78 =	\$ 0
Fee for Multiple dependent claims.....	\$ 260 =	\$ 0

Filing Fee, Charge to Deposit Account No. 23-1950..... \$ 690

**ATTACH DUPLICATE COPY OF THIS PAGE**

Respectfully submitted,

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RJK/pmc

## PCMCIA CARD

### REFERENCE TO RELATED APPLICATION

This application claims the benefit of U.S. Provisional Application No. 60/172,399 filed on December 17, 1999, which is incorporated herein by reference.

5

### FIELD OF THE INVENTION

This invention relates to electronic communication devices. More particularly, the present invention relates to connectors used to attach a communications line to a computer.

### BACKGROUND OF THE INVENTION

10

Many of today's computers, computer peripherals and other electronic products are designed to receive removable devices or cards, conforming to standards established by the Personal Computer Memory Card International Association (PCMCIA). These standards define the electrical and physical specifications of the card, including the interfaces between the card and the port or slot into which the card is inserted, as well as

15 three card form factors, called Type I, Type II and Type III.

20

PCMCIA cards may be used for various purposes such as, for example, to establish a communications link between portable computer users and corporate networks, the Internet and other on-line services from a wide variety of locations; to supplement the semiconductor memory of a personal or notebook computer; to store information or data

for use by the host system; or to reconfigure the host system in response to information stored in the card.

PCMCIA cards typically include a substrate, usually rectangular and in the form of a printed circuit board (PCB) which contains electronic components including integrated circuit packages. The PCB is attached along one of its edges to a multiple connector typically including a connector of molded plastic having multiple contacts for electrically  
5 connecting the card to the host system by way of a port or slot. A typical PCMCIA card further includes a molded plastic, insulative frame and a sheet metal cover including upper and lower cover panels enclosing the PCB and having forward margins secured to upper and lower surfaces of the plastic connector. The metal cover not only protects the PCB, but also acts as a shield against electromagnetic interference.

10 Although effective as a protective shield against both physical damage and EMI, the metal shield tends to be limited in shape and is aesthetically less appealing than plastic. More specifically, because the panels tend to be pressed from sheet metal, multiple press runs are required to obtain the more intricate shapes that are desirable for today's highly-stylized PCMCIA cards which conform closely to the components they contain. As the  
15 number of press runs increases, however, so do manufacturing costs. Therefore, the shape of a metal panel usually is a compromise between the desired shape and manufacturing costs. Additionally, metal panels tend to be less aesthetically pleasing than plastic due to limitations in the texture and finish of the panel body.

Shape and aesthetic considerations thus tend to favor the use of plastic for such  
20 panels, given the moldability and flexibility plastic affords. Plastic panels have several shortcomings, however, which have traditionally discouraged their use. Specifically, plastic panels tend to be difficult to join to complementing metal panels using traditional techniques such as adhesion. A traditional approach for avoiding a plastic-to-metal connection is to use plastic inserts within the complementing metal panel and

ultrasonically weld the plastic inserts to the plastic panel. Although effective, this approach requires additional components and manufacturing steps and therefore tends to be relatively expensive.

Therefore, there is a need for a PCMCIA card configuration that facilitates the use of highly moldable and aesthetically pleasing materials such as plastics, while not sacrificing the strength and EMI protection offered by metal. Such a card should also be fabricated using conventional techniques such as ultrasonic welding. The present invention fulfills these needs among others.

#### SUMMARY OF THE INVENTION

The present invention provides for a card having a configuration that facilitates the use of aesthetically pleasing moldable materials for a portion of the cover while avoiding the problems in conventional metal-to-plastic construction as mentioned above. To this end, the plastic panel and the conductive panel are configured to interconnect using ultrasonic welding. More specifically, the conductive panel is configured with tabs having barbs thereon and the plastic panel is configured with slots to receive the barbs. Upon application of sufficient energy, the plastic flows around the barbs, thereby anchoring them in the plastic and preventing separation of the plastic and metal panels.

Accordingly, one aspect of the invention is a card having plastic and metal panels joined together through ultrasonic welded or similar technique. In a preferred embodiment, the card comprises: (a) a circuit board; (b) a connector electrically connected to the circuit board and adapted for electrically connecting the circuit board to a host computer; (c) a housing having the circuit board mounted therein and configured to provide access to the connector, the housing comprising a metal panel interconnected to a

plastic panel, the metal panel comprising a plurality of tabs with barbs thereon, the plastic panel having one or more cavities receiving the tabs; and (d) wherein the plastic of the plastic panel at least partially engulfs the barbs of the tabs to prevent withdrawal of the tabs from the one or more cavities and thereby interconnect the plastic and metal panels.

- 5           Another aspect of the invention is a process for manufacturing a card having a plastic panel joined to a metal panel. In a preferred embodiment, the process comprises: (a) placing a circuit board within a plastic panel and a metal panel, the metal panel having a plurality of tabs with barbs, the plastic panel having one or more cavities adapted for receiving the tabs; (b) inserting the tabs within the one or more cavities; and (c)
- 10   transmitting energy to the plastic around the tab such that it flows at least partially around the barbs.

Yet another aspect of the invention is a card made from the process of the present invention.

- Still another aspect of the invention is a communication device comprising the card
- 15   of the present invention.

#### **BRIEF DESCRIPTION OF THE DRAWINGS**

Figure 1 shows an exploded, top perspective view of the card of the present invention;

Figure 2 shows an exploded, bottom perspective view of the card of Figure 1;

- 20   Figure 3 shows the grounding shield of the card of Figure 1;

Figure 4 shows a top perspective view of the plastic panel of the card of Figure 1;

Figure 5 shows a bottom perspective view of the plastic panel of the card of Figure 1; and

Figure 6 shows the detail of the tabs along the metal panel in position before insertion into the groove along the interface of the plastic cover.

5                   **DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENT**

It will be evident to those skilled in the art that although the invention is described herein with reference to an Ethernet LAN (local area network) communications card conforming to certain PCMCIA size and interface standards, the invention can be applied to cards complying with other PCMCIA size and interface standards and performing other  
10 functions. For example, the card can serve as a local area network adapter, a voice mail device, a facsimile device, a modem, or can combine LAN adapter and modem functions. Accordingly, the appended claims are not intended to be limited to PCMCIA cards of any specific form factor, interface or function. All of these devices are examples of those  
15 intended to come within the scope of the meaning of the term "communication devices" as used herein. Even further, other devices which require communication with one or more additional devices which are now available or which may become available in the future are intended to also come within the meaning of the term communication devices as used herein.

Referring first to Figures 1 and 2, there is shown an exploded view of a generally  
20 rectangular Ethernet LAN communications card 10 incorporating the present invention. The card 10 conforms to the PCMCIA Type III and 16-bit interface standards. The card 10 comprises the following basic components: (a) a circuit board 14 having a connector 15 connected along a front edge 20 thereof and adapted for electrical connection to a host

computer (not shown); (b) a housing for containing the circuit board 12 comprising a plastic top panel 11 with an opening 21 around the connector 15 and a conductive bottom panel 19 interconnected with the top panel 11; and (c) a conductive grounding shield 12 overlying a substantial portion of the circuit board 14 and at least a portion of the

5 connector 15, and being electrically connected to the bottom panel 19. It should be noted that terms such as "top," "bottom," "upper," "lower," "vertical," and the like, are used herein only to facilitate the description of the structure of the card illustrated and should not be used to limit the scope of the invention. Furthermore, it should be evident that the card may be used in any orientation.

10 The circuit board 14 supports integrated circuit and other electronic components, for example, circuitry necessary for carrying out LAN communication functions which are not depicted although well known in the art. Disposed along a front or forward transverse end 20 of the card 10 is the connector 15 designed to be removably coupled to a

15 corresponding pin connector within a receiving slot of a host system (not shown). The connector 15 may be made of molded plastic and include upper and lower transverse rows of longitudinally extending holes (not shown) each containing a contact for receiving a corresponding pin of the male connector on the host system. Each connector contact includes a rearwardly extending contact finger soldered to an associated conductive trace on the terminal section of the PCB 14. The connector pin assignments are established

20 typically by a PCMCIA 16-bit interface standard. In accordance with the PCMCIA standard, the connector 15 has 68 contacts arranged in two rows of 34 contacts each, with the four end contacts (corresponding to pin Nos. 1, 34, 35 and 68) being assigned ground potential. The connector 15 further includes an upper, horizontal, planar surface 21, opposite ends 22 and 23, and a rear transverse side 24 from which the contact fingers 25

project. Overlying the upper surface 21 of the connector 15 is an extension 13 of the inner ground plate 12 (described later).

The card 14 has parallel, longitudinally extending sides 26, 27 and a transversely extending rear end 28. The rear end 28 of the card 14 has optional input/output ports 29, 30, 31 for connection to a communication line. Depending upon the application, the communication card may comprise additional connectors such as RJ-xx series connectors. Detailed information regarding the RJ-xx series of connectors can be found in the publication found at Title 47 (Telecommunications), Code of Federal Regulations, Chapter I (Federal Communications Commission), Subchapter B (Common Carrier Services), Part 68 (Connection of Terminal Equipment to the Telephone Network), Subpart F (Connectors), Section 68.500 (1992) which is now incorporated herein by reference in its entirety. Preferably, the port 30 is an eight conductor RJ-45 receptacle, which is called for in some computer network standards, and the other port 29 is a six conductor RJ-11 receptacle. Port 31 preferably is a connector which is attached directly to a corresponding connector (not shown) on a portable cellular telephone (not shown) or other communication device.

The circuit board and connector(s) assembly is contained in the top and bottom panel sections 11, 19. The top panel 11 comprises an aesthetically pleasing material, preferably a plastic, which can be molded readily to any shape and textured as desired. Suitable plastics are well known in the art, although a polycarbonate/ABS blend is preferred. As shown in Figure 4, the top panel 11 is profiled to define a cut-out section 33 to accommodate the connector 15. The top panel 11 is molded to increase the profile of the card immediately behind the connector 15 thereby providing the card with a



relatively large internal volume. It should be understood, however, that the top panel is not restricted in shape since it is formed of a highly moldable material.

The bottom panel 19 is preferably formed of stamped metal and cooperates with the grounding shield to provide a ground path from the shield to the chassis in which the card is mounted. Consequently, the bottom panel 19 is configured to contact the chassis of the computer, preferably along the periphery of the slot that accommodates the card.

As shown in Figure 1 and 2, the panels 11, 19 contain the grounding shield 12 which overlies the circuit board 14. The grounding shield 12 covers a substantial portion of the circuit board, preferably at least about 75% and, more preferably, at least about 90% of the PCB's area. In addition to covering the PCB, as mentioned above, the grounding shield comprises a portion 13 that covers at least a portion of the connector 15. In the embodiment shown in Figure 3, the portion 13 is an extension of the main body of the grounding shield. By covering the connector, the grounding shield provides protection from EMI and external aggression. Furthermore, because it is metal, the portion 13 can be very thin, for example, about 0.008", while still possessing the desired strength. The use of the grounding shield avoids covering the connector with a thin section of plastic from the top panel 11 which would be structurally weak and provide little or no EMI protection. For example, plastic less than about 0.020" tends to be structurally unsuitable for covering an area as large as the top 21 of the connector 15.

The grounding shield 12 is electrically connected to the bottom panel 19 to provide a ground path through the bottom panel to the chassis in which the card is mounted. Techniques for electrically connecting the grounding shield to the bottom panel are well known and include, for example, a physical connection between the two components or an electrical conduit between them. In the embodiment of Figures 1 and 2, the grounding

shield 12 is mounted to the bottom panel 19. This approach not only provides an electrical connection between the components, but also secures the grounding shield within the card.

The present invention also provides plastic and metal panel configurations that can be “welded” together using conventional techniques such as ultrasonic welding. More specifically, referring to Fig. 5 where the underside of the top panel 11 is depicted, it can be seen that a channel 34 is formed along the panel’s interface with the bottom panel. This channel provides a cavity to receive projections from the bottom panel.

As shown in Figure 6, the bottom panel 19 comprises tabs 61 which are insertable into the channel 34 to engage the bottom and top panels. The tabs have a particular geometry or otherwise comprise one or more structures which provide a purchase point for plastic flowing around them. In other words, when plastic flows around the geometry or structures and partially or fully envelopes them, the tab is anchored in the plastic. These structures/geometry are collectively referred to herein as “barbs.” In addition to providing a purchase point for flowed plastic, these barbs are preferably configured to be insertable into cavities, but to resist withdrawal. To this end, the barbs are preferably configured to be flexible or to present no edge or high-friction surface in one direction, while being rigid or presenting an edge or high-friction surface in the opposite direction. For example, the barbs 62 have edges 63 that dig into the side 64 of the channel 34 as the tabs are withdrawn from the channel, thereby preventing separation of the metal panel 19 from the plastic panel 11.

Transmitting energy to the plastic around the barbs such that it flows around them can be effected in different ways. For example, this may be accomplished by first inserting the tabs 61 within the channel 34 and then applying ultrasonic energy.

Alternatively, energy may be applied to the assembly while inserting the tabs into the channels thereby allowing the barb to plow through the softened plastic.

Any known energy for causing plastic to flow may be used, although ultrasonic energy is preferred. The ultrasonic energy may be applied in any known manner to the plastic around the tab 61, although it is preferred to apply the energy to the metal panel 5 19, which is a good conductor of such energy, rather than to the plastic panel since ultrasonic energy tends to blemish the finish of plastic components.

**WHAT IS CLAIMED IS:**

1. A card for insertion into a receiving slot of a host computer, said card comprising:  
a circuit board;  
5 a connector electrically connected to said circuit board and adapted for electrically  
connecting said circuit board to a host computer;  
a housing having said circuit board mounted therein and configured to provide  
access to said connector, said housing comprising a metal panel  
interconnected to a plastic panel, said metal panel comprising a plurality of  
10 tabs with barbs thereon, said plastic panel having one or more cavities  
receiving said tabs; and  
wherein the plastic of said plastic panel at least partially engulfs said barbs of said  
tabs to prevent withdrawal of said tabs from said one or more cavities and  
thereby interconnect said plastic and metal panels.  
15
2. The card of claim 1, wherein said card is a PCMCIA card.
3. The card of claim 2, wherein said card conforms to the PCMCIA, Type III  
standard.  
20
4. The card of claim 1, further comprising a second connector.
5. The card of claim 4, wherein said second connector is an RJ-xx series connector

6. A process of manufacturing a card comprising:  
placing a circuit board within a plastic panel and a metal panel, said metal panel  
having a plurality of tabs with barbs thereon extending along an interface  
portion, said plastic panel having one or more cavities adapted for receiving  
said tabs;  
inserting the tabs within said one or more cavities; and  
transmitting energy to the plastic around said tab such that said plastic flows at  
least partially around said barbs.

7. The process of claim 6, wherein said energy is applied to said metal panel.

8. The process of claim 6, wherein said energy is ultrasonic energy.

9. The process of claim 6, wherein said energy is applied while the tabs are being  
inserted into said cavities.

10. The process of claim 6, wherein said energy is applied after said tabs are inserted  
into said cavities.

11. A card from the process of claim 6.

12. The card of claim 11, wherein said card is a PCMCIA card.

13. The product from the process of claim 7.

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14. The product from the process of claim 8.

### ABSTRACT

A PCMCIA card has a plastic top panel and a metal bottom panel which are configured to interconnect using ultrasonic welding. The top panel has slots along its perimeter, and the bottom panel has tabs with barbs that are received in the slots. Upon  
5 application of sufficient energy, portions of the plastic top panel flow around the barbs, thereby anchoring the barbs in the plastic and preventing separation of the plastic and metal panels. This configuration allows the top panel to be made from aesthetically pleasing moldable materials while avoiding problems associated with conventional metal-to-plastic construction.





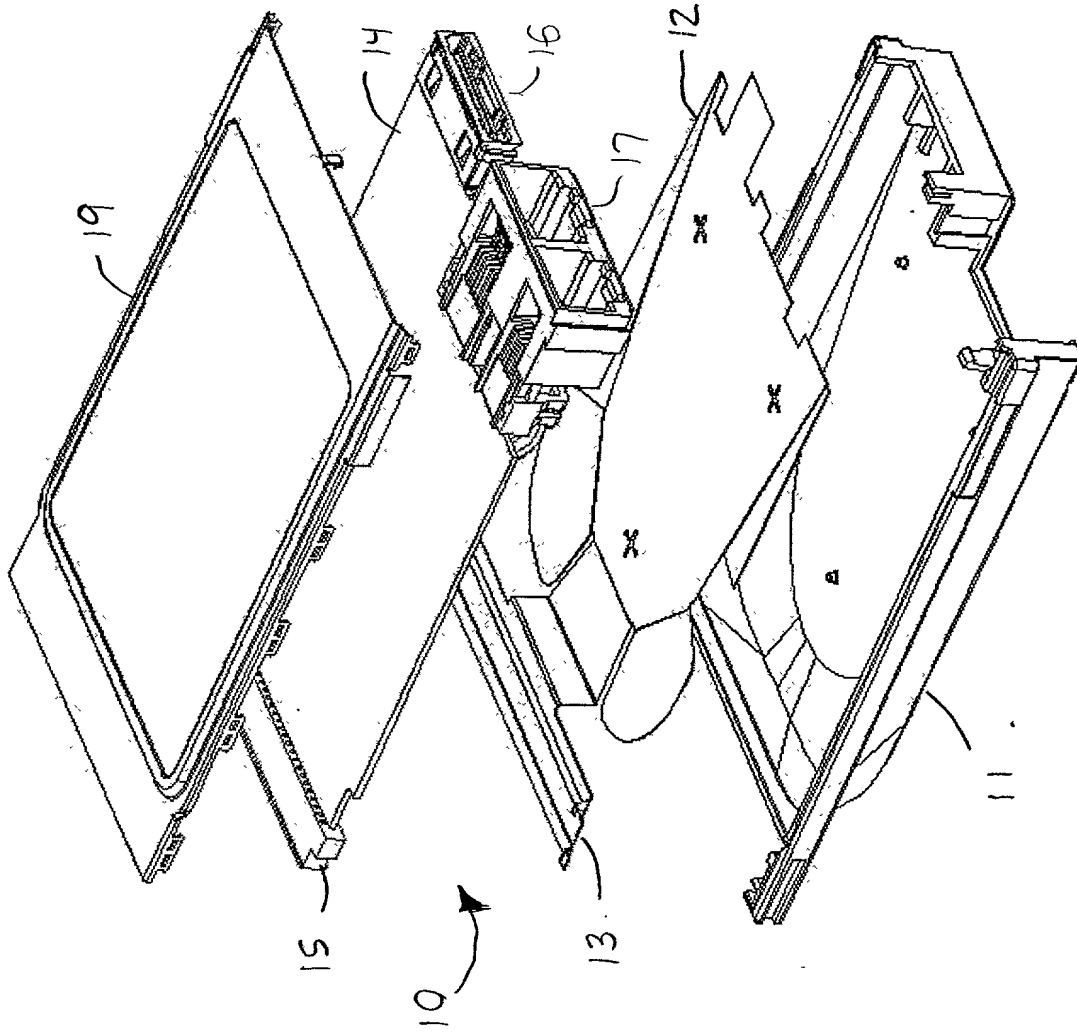


Fig. 2

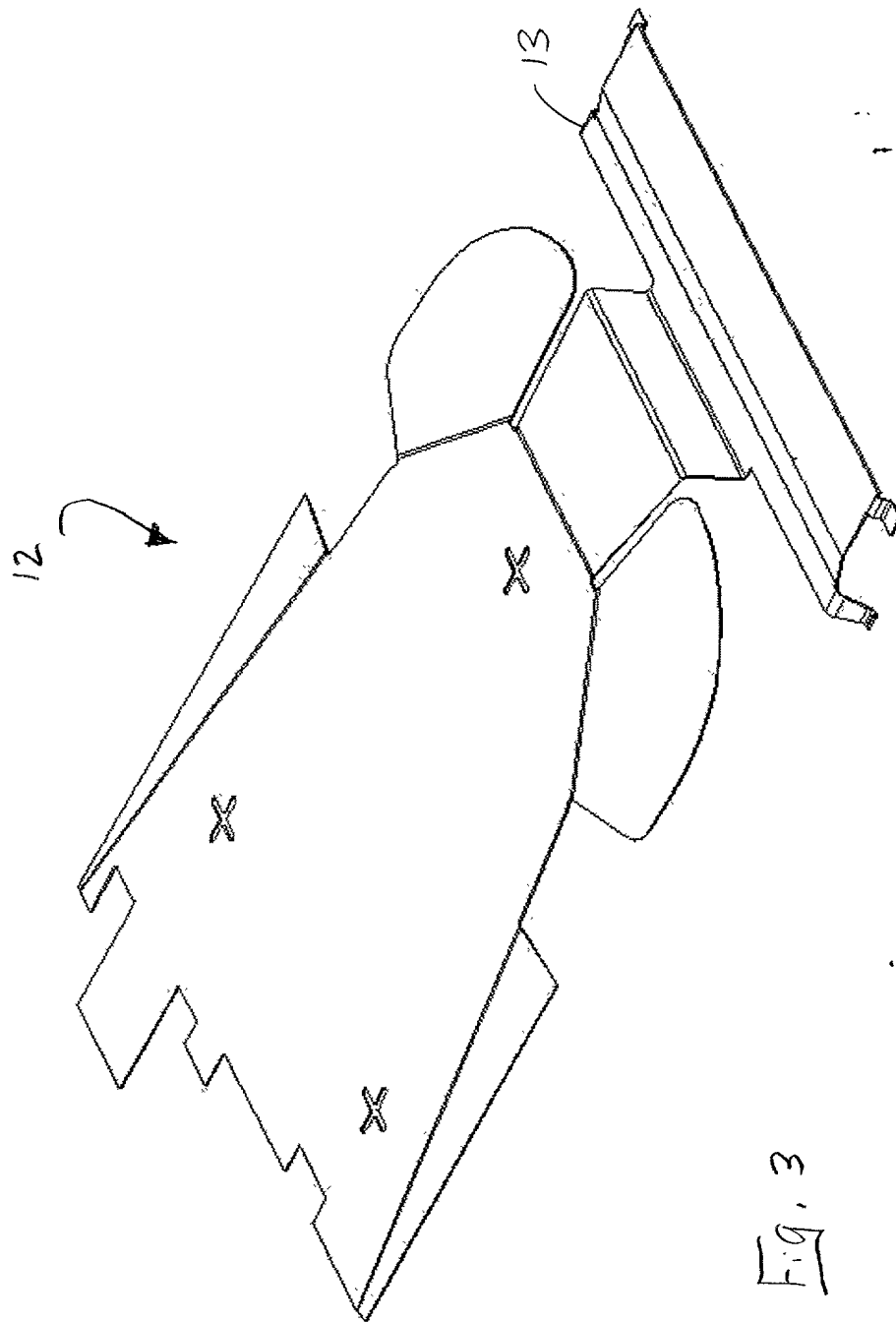


Fig. 3

X.X	+0.5
X.XX	+0.13
X.XXX	+0.013

INSTANCE: GENERIC



000001 01564500

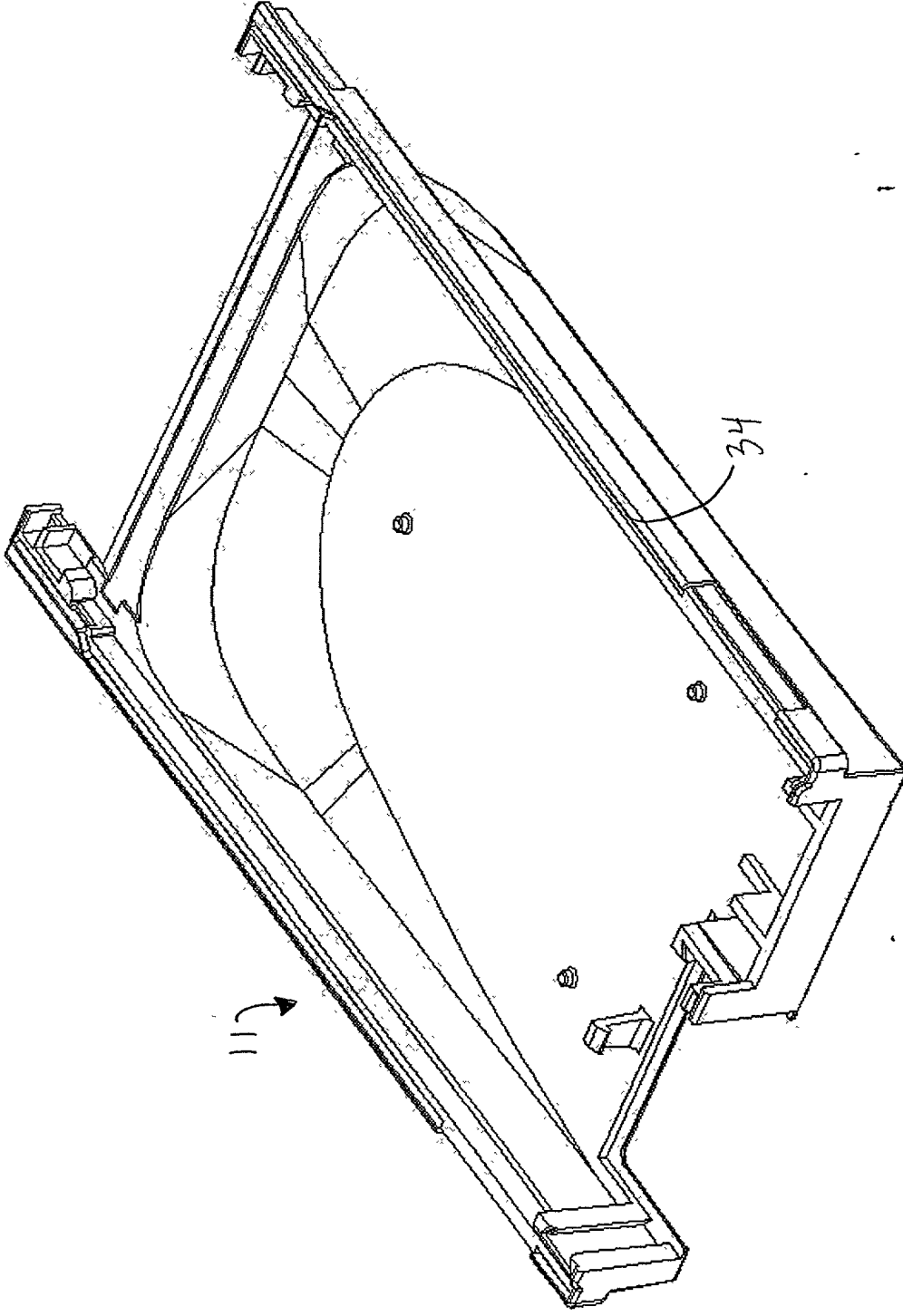
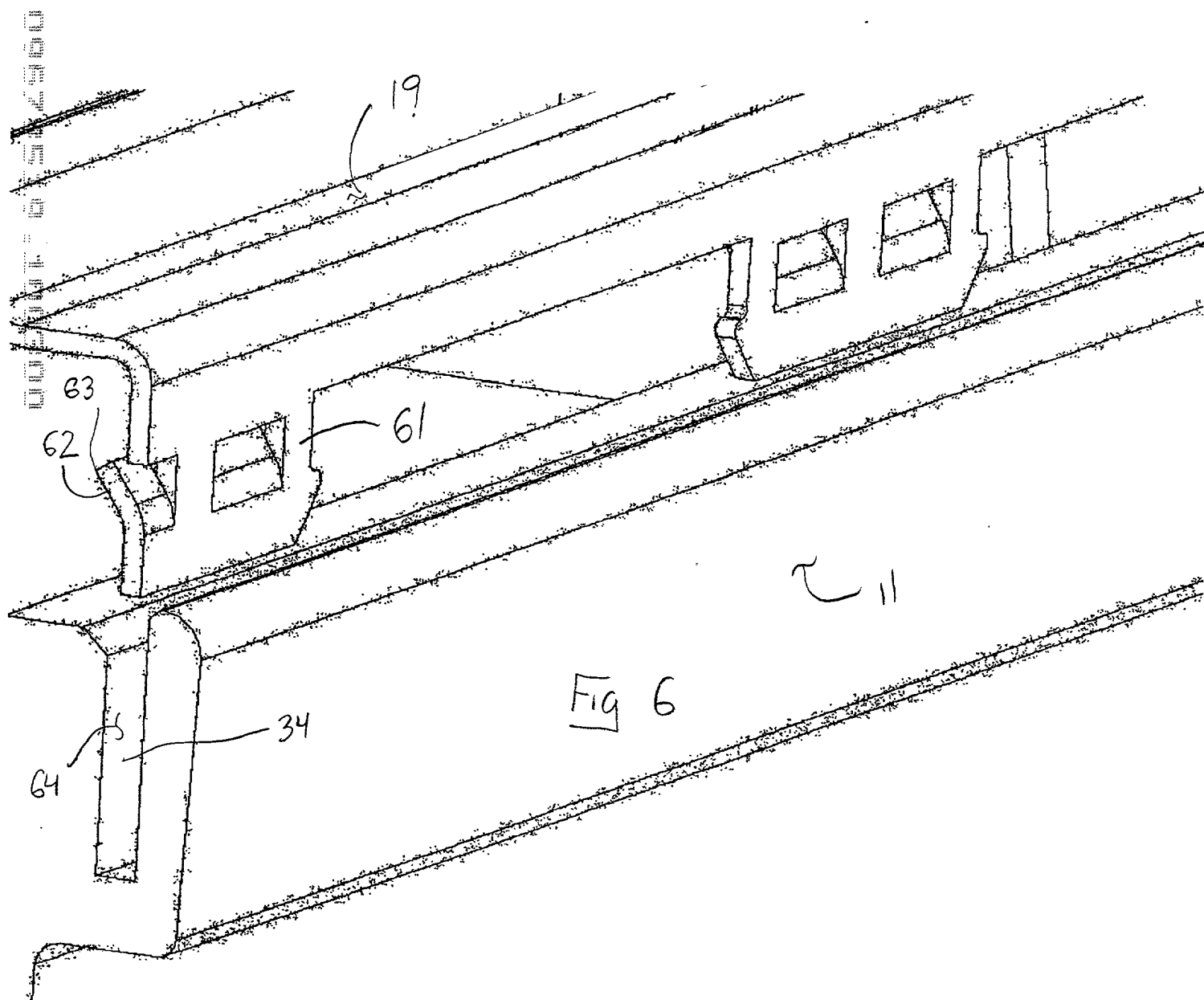


Fig. 5

X.X	+0.1	INSTANCE: GENERIC
X.XX	+0.01	
X.XXX	+0.001	
ANG	1.0E-5	



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Docket No. 17498

DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare, of my own knowledge or on information and belief, that:

My residence, post office address and country of citizenship are as stated below next to my name;

I am the original, first and sole inventor, if only one inventor is identified below, or an original, first and joint inventor, if more than one inventor is identified below, of the subject matter which is claimed and for which a patent is sought and which is entitled:

PCMCIA CARD

and which is described and claimed:

  X   in the attached application including specification and claims if this line is marked, or  
       in the original specification and claims filed on        as U.S. Patent Application Number        or PCT International Application Number       .

I have reviewed and understand the contents of the specification and the claims;

I acknowledge the duty to disclose information which is material to the examination of the application in accordance with 37 CFR §1.56(a). The text of 37 CFR §1.56(a) states,

"A patent by its very nature is affected with a public interest. The public interest is best served, and the most effective patent examination occurs when, at the time an application is being examined, the Office is aware of and evaluates the teachings of all information material to patentability. Each individual associated with the filing and prosecution of a patent application has a duty of candor and good faith in dealing with the Office, which includes a duty to disclose to the Office all information known to that individual to be material to patentability as defined in this section. The duty

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to disclose information exists with respect to each pending claim until the claim is cancelled or withdrawn from consideration, or the application becomes abandoned. Information material to the patentability of a claim that is canceled or withdrawn from consideration need not be submitted if the information is not material to the patentability of any claim remaining under consideration in the application. There is no duty to submit information which is not material to the patentability of any existing claim. The duty to disclose all information known to be material to patentability is deemed to be satisfied if all information known to be material to patentability of any claim issued in a patent was cited by the Office or submitted to the Office in the manner prescribed by §§ 1.97(b)-(d) and 1.98. However, no patent will be granted on an application in connection with which fraud on the Office was practiced or attempted or the duty of disclosure was violated through bad faith or intentional misconduct. The Office encourages applicants to carefully examine: 1) prior art cited in search reports of a foreign patent office in a counterpart application, and 2) the closest information over which individuals associated with the filing or prosecution of a patent application believe any pending claim patentably defines, to make sure that any material information contained therein is disclosed to the Office;"

I hereby claim the benefit under 35 USC §119(e) of any United States provisional application(s) listed below.

Provisional Application No.: 60/172,399  
Filing Date: December 17, 1999

This application is a continuation pursuant to 35 USC §120 of each prior application (if any is identified) identified as follows:

U.S. Serial No.: \_\_\_\_\_  
U.S. Filing Date: \_\_\_\_\_ Status: \_\_\_\_\_

This application is a continuation-in-part pursuant to 35 USC §120 of each prior application (if any is identified) identified as follows:

U.S. Serial No: \_\_\_\_\_  
U.S. Filing Date: \_\_\_\_\_ Status: \_\_\_\_\_

and I acknowledge the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR §1.56(a) which became available between the filing date

of the prior application and the national or PCT international filing date of the continuation-in-part application.

I claim foreign priority, pursuant to 35 USC §119(a)-(d) of an application for patent or inventor's certificate, and identify below said application (if any is identified) and any such foreign application (if any is identified) having a filing date before that of the application on which foreign priority is claimed;

Application No: \_\_\_\_\_ Country: \_\_\_\_\_  
Filing Date: \_\_\_\_\_

I hereby declare that all statements made of my own knowledge are true and that all statements made on information and belief are believed to be true, and I am warned that willful false statements and the like are punishable by fine or imprisonment, or both, (18 USC §1001) and may jeopardize the validity of the application or any patent issuing thereon.

I hereby appoint Michael J. Aronoff (Registration No. 37770), Brian K. Dinicola (Registration No. 36122), Bradley N. Ditty (Registration No. 40994), Robert J. Kapalka (Registration No. 34198), Driscoll A. Nina, Jr. (Registration No. 34685), and Mark K. Young, (Registration No. 38666) and whose post office address is: The Whitaker Corporation, 4550 New Linden Hill Road, Suite 450, Wilmington, DE 19808-2952, or their duly appointed associate, my attorneys or agents with full powers of substitution and revocation, to prosecute this application, to make alterations and amendments therein, to receive the Letters Patent, and to transact all business in the U.S. Patent and Trademark Office in connection therewith.

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Randy Gray Simmons

Full Name of First Inventor

*Randy Gray Simmons*  
Inventor's Signature

9/21/00  
Date

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